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STMicroelectronics EMIF02-USB02F2

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# EMIF02-USB02F2

## 2-line IPAD<sup>™</sup>, EMI filter with ESD protection

## Features

- 2-line low-pass filter + ESD protection
- High efficiency in EMI filtering
- Lead-free package
- Very low PCB space occupation < 3.2 mm<sup>2</sup>
- Very thin package: 0.65 mm
- High efficiency in ESD suppression
- High reliability offered by monolithic integration
- High reduction of parasitic elements through integration and wafer level packaging

## Complies with the following standards:

- IEC 61000-4-2
  - 15 kV (air discharge)
  - 8 kV (contact discharge)
- MIL STD 883E Method 3015-6 Class 3

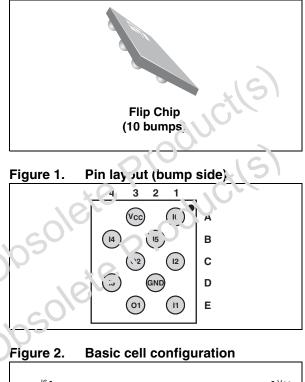
## Application

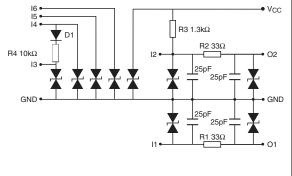
EMI filtering and ESD p cter tion for USB port.

## Description

The EMIF'02-USB02F2 is a highly integrated array designed to suppress E'M. / BFI noise for a USB port. The EMIF02-USB02F2 Flip Chip packaging means the package size is equal to the die size.

Additionally chis filter includes ESD protection circuitry which prevents damage to the application when subjected to ESD surges up to 15 kV.







## **Characteristics**

## EMIF02-USB02F2

### **Characteristics** 1

Table 4			/ <del>-</del>	
Table 1.	Absolute	ratings	(I <sub>amh</sub> =	:25°C)

Symbol	Parameter and test conditions	Value	Unit	
V <sub>PP</sub>	ESD discharge IEC 61000-4-2, air discharge ESD discharge IEC 61000-4-2, contact discharge	15 8	kV	
Тj	Junction temperature	125	°C	
Т <sub>ор</sub>	Operating temperature range	- 40 to + 85	°C	
T <sub>stg</sub>	Storage temperature range	- 55 to + 150	°C	
Table 2.    Electrical characteristics (T <sub>amb</sub> = 25 °C)				

## Table 2.

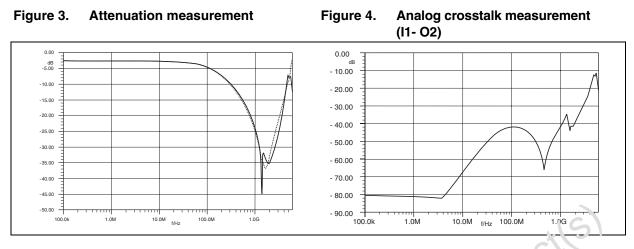
## Electrical characteristics (T<sub>amb</sub> = 25 °C)

Symbol	Parameter	L.		(G)		
V <sub>BR</sub>	Breakdown voltage       Leakage current @ V <sub>RM</sub> Stand-off voltage					
I <sub>RM</sub>				5		
V <sub>RM</sub>						
V <sub>CL</sub>	Clamping voltage	t IR VRM VBR VCL			V	
R <sub>d</sub>	Dynamic impedance					
I <sub>PP</sub>	Peak pulse current					
R <sub>I/O</sub>	Series resistance between input					
C <sub>line</sub>	Input capacitance per line					
Symbol	Test conditions	Min.	Тур.	Max.	Unit	
V <sub>BR</sub>	I <sub>P</sub> = IrA	6			V	
I <sub>Ri</sub> ,	V <sub>RM</sub> = 3V		0.1	0.5	μA	
Cine	@ 0V			50	pF	
					Ω	
$R_1, R_2$	Tolerance ± 5%		33		52	
R <sub>1</sub> ,R <sub>2</sub> R <sub>3</sub>	Tolerance ± 5% Tolerance ± 5%		33 1.3		kΩ	



## EMIF02-USB02F2

Characteristics



# Figure 5. ESD response to IEC 61000-4-2 (+15kV contact discharge)

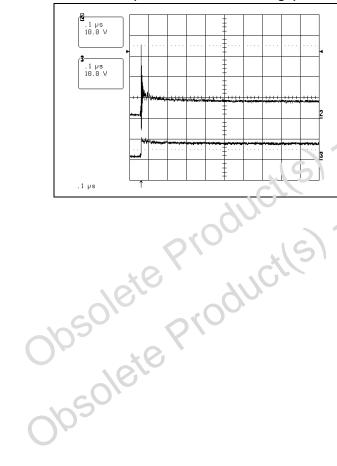
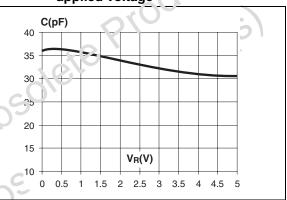


Figure 6. Line capacitance versus reverse applied voltage





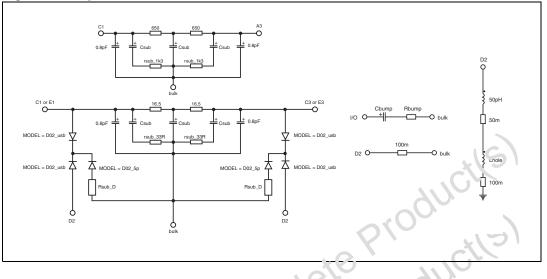
## **Application information**

EMIF02-USB02F2

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### **Application information** 2

#### Figure 7. Aplac model of D+ & D- cells



#### Figure 8. Aplac model parameters

Cz 17pF opt Ls 0.4nH Rs 0.1 Rsub_D 10 Csub 0.3pF Rsub_33R 16 Rsub_1k3 13 Ihole 1.0pH opt Cbt mp 1.2pF opt Rb1n.2p 350	D02_usb dio 100 model + B'	D02_5p diodes model + BV = 100 + IBV = 1m + CJO = 5p + M = 0.3333 + RS = 2 + VJ = 0.6 + TT = 100n
Rbun:: 5350	$\sim$	

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# Ordering information scheme

## Ordering information scheme

Figure 9.	Ordering information scheme
×C`	EMIF yy - xxx zz Fx
	EMI Filter
SOF	Number of lines
	Information
	x = resistance value (Ohms)
	z = capacitance value / 10(pF)
	or
	3 letters = application
	2 digits = version



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## EMIF02-USB02F2

**Package information** 

## 4 Package information

In order to meet environmental requirements, ST offers these devices in ECOPACK<sup>®</sup> packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at *www.st.com*.



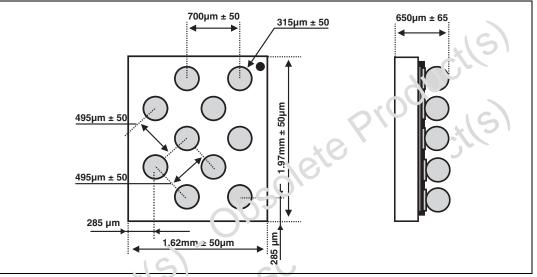
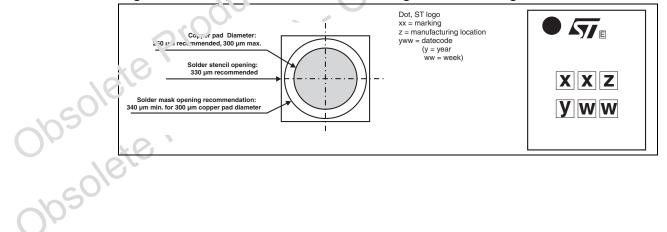


Figure 11. Footorint ecommendations Figure 12. Marking

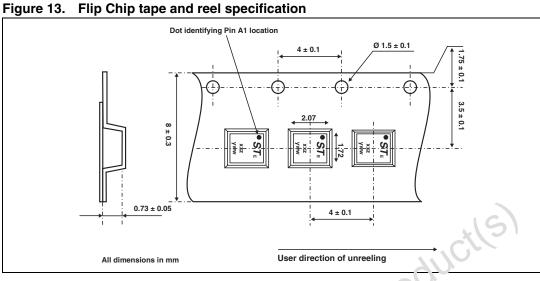




## **Ordering Information**

## EMIF02-USB02F2

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# More information is available in the application notes: Note: psolete Product AN1235: "Flip Chip: Package description and recommendatic"s for use" AN1751: "EMI Filters: Recommendations and measurer ents"

### **Ordering Information** 5

#### Table 3. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
EMIF02-USB02-2	FG	Flip Chip	4.25 mg	5000	Tape and reel 7"

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# **Revision history**

### Table 4. **Document revision history**

0 <sup>050</sup>	Table 4.     Document revision history		
	Date	Revision	Changes
$cO^{\prime}$	14-Dec-2004	1	First issue
005	28-Apr-2008	2	Updated ECOPACK statement. Updated <i>Figure 9, Figure 10, Figure 12</i> , and <i>Figure 13</i> . Reformatted to current standards.



### EMIF02-USB02F2

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